L	Hits	Search Text	DB	Time stamp
Number				0000/00/05
_	168964	connect\$4 near5 layer	USPAT;	2003/09/05
			US-PGPUB;	16:07
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
_	15380	(connect\$4 near5 layer) and horizontal	USPAT;	2003/09/05
		and vertical	US-PGPUB;	16:31
			EPO; JPO;	
		•	DERWENT;	
			IBM TDB	
_	125	((connect\$4 near5 layer) and horizontal	USPAT;	2003/09/05
		and vertical) and pld	US-PGPUB;	16:09
		F	EPO; JPO;	
			DERWENT;	
			IBM TDB	
_	2514	((connect\$4 near5 layer) and horizontal	USPAT;	2003/09/05
_	2314	and vertical) and pitch	US-PGPUB;	16:31
		and vertical, and proon	EPO; JPO;	10.01
			DERWENT;	
			IBM TDB	
	4130	horizontal near4 pitch	USPAT;	2003/09/05
-	4130	norizontal hear4 proch	US-PGPUB;	17:25
			EPO; JPO;	17.25
			DERWENT;	
•		Carl Tourism A market	IBM_TDB USPAT;	2003/09/05
_	0	veritical near4 pitch		17:25
			US-PGPUB;	17:25
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	0000 /00 /05
_	5611	vertical near4 pitch	USPAT;	2003/09/05
			US-PGPUB;	17:25
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
_	86	1 1	USPAT;	2003/09/05
		near4 pitch) and (vertical near4 pitch)	US-PGPUB;	17:56
			EPO; JPO;	
			DERWENT;	
	1		IBM TDB	

	ט	1	Document ID	Issue Date	Pages	Title	Current OR
1	×		US 20030155517 A1	20030821	51	Radiation detecting element, radiation image pickup apparatus and radiation detecting method	250/370.09
2	⊠		US 20030153834 A1	20030814	15	Ultrasound probe wiring method and apparatus	600/459
3	×		US 20030151147 A1	20030814	20	Electrical assembly with vertical multiple layer structure	257/779
4	⊠	0	US 20030151146 A1	20030814	20	Vertical electronic circuit package and method of fabrication therefor	257/779
5	Ø		US 20030141926 A1	20030731	26	Semiconductor integrated circuit device	327/565
6	×		US 20030127599 A1	20030710	51	Radiation detector, radiation imaging system, radiation detecting method and radiation imaging method	250/370.01
7	⊠		US 20030076469 A1	200,30424	12	Wide viewing angle fringe field multi-domain aligned LCD and method for fabricating	349/129
8	×		US 20030052945 A1	20030320	13	High density element structure formed by assembly of layers and method for making same	347/53
9	×		US 20030028105 A1	20030206	15	Ultrasound probe wiring method and apparatus	600/437
10	Ø		US 20030026564 A1	20030206	115	Display device and method for producing the same	385/120
11	Ø		US 20030025442 A1	20030206	106	Display device and method for producing the same	313/495
12	Ø		US 20030020503 A1	20030130	21	Test vehicle with zig-zag structures	324/754
13	×		US 20030003705 A1	20030102	20	Vertical electronic circuit package and method of fabrication therefor	438/612

	U	1	Document ID	Issue Date	Pages	Title	Current OR
14	Ø		US 20030001477 A1	20030102	35	Electron-emitting device, electron source, and image-forming apparatus	313/310
15			US 20020195662 A1	20021226	51	Power semiconductor switching devices, power converters, integrated circuit assemblies, integrated circuitry, power current switching methods, methods of forming a power semiconductor switching device, power conversion methods, power semiconductor switching device packaging methods, and methods of forming a power transistor	257/349
16	×		US 20020154259 A1	20021024	19	Light-producing high aperture ratio display having aligned tiles	349/73
17	⊠		US 20020105009 A1	20020808	50	Power semiconductor switching devices, power converters, integrated circuit assemblies, integrated circuitry, power current switching methods, methods of forming a power semiconductor switching device, power conversion methods, power semiconductor switching device packaging methods, and methods of forming a power transistor	257/138
18	×		US 20020096994 A1	20020725	70	Image display unit and method of producing image display unit	313/495

	บ	1	Document ID	Issue Date	Pages	Title	Current OR
19			US 20020076851 A1	20020620	41	Power semiconductor switching devices, power converters, integrated circuit assemblies, integrated circuitry, power current switching methods, methods of forming a power semiconductor switching device, power conversion methods, power semiconductor switching device packaging methods, and methods of forming a power transistor	438/106
20	×		US 20020030436 A1	20020314	29	Electron-emitting device, electron source and image-forming apparatus	313/495
21	×		US 20020024671 A1	20020228	33	ALIGNING METHOD, ALIGNER, AND DEVICE MANUFACTURING METHOD	356/401
22	\boxtimes		US 20020005549 A1	20020117	41	Power semiconductor device and method of manufacturing the same	257/328
23			US 20010049813 A1	20011206	19	INTEGRATED CIRCUIT INCORPORATING A POWER MESH	716/8
24.	×		US 20010043084 A1	20011122	32	Semiconductor integrated circuit apparatus	326/98
25	⊠		US 20010024460 A1	20010927	22	Semiconductor light-emitting device	372/36
26	×		US 20010022564 A1	20010920	14	Led display assembly	345/55

	ט	1	Do	cument ID	Issue Date	Pages	Title	Current OR
27	×		US 200 A1	010001744	20010524	16	Semiconductor device and method of manufacturing the same	438/738
28	×		US B2	6613610	20030902	67	Image display unit and method of producing image display unit	438/128
29			US B1	6611951	20030826	21	Method for estimating cell porosity of hardmacs	716/12
30	×		US B1	6603256	20030805	24	Field emission type display	313/496
31	×		US B2	6590425	20030708	31	Semiconductor integrated circuit apparatus	326/98
32	×		US B1	6583041	20030624	9	Microdevice fabrication method using regular arrays of lines and spaces	438/618
33	×		US B2	6582371	20030624	14	Ultrasound probe wiring method and apparatus	600/459
34	Ø		US B2	6555920	20030429	19	Vertical electronic circuit package	257/779
35			US B2	6549179	20030415	13	LED display assembly	345/39
36			US B1	6532572	20030311	11	Method for estimating porosity of hardmacs	716/4
37	⊠	0	US B1	6518180	20030211	34	Method for fabricating semiconductor device and method for forming mask suitable therefor	438/671

	ט	1	Do	cument ID	Issue Date	Pages	Title	Current OR
38	×		US B1	6514618	20030204		Multilayer backing material for 2-D ultrasonic imaging arrays	428/413
39	⊠		US B1	6497667	20021224	11	Ultrasonic probe using ribbon cable attachment system	600/459
40			US B2	6480989	20021112	17	Integrated circuit design incorporating a power mesh	716/8
41	Ø		US B2	6465844	20021015	36	Power semiconductor device and method of manufacturing the same	257/336
42	×		US B1	6463185	20021008	28	Information recording medium and information reproducing apparatus	382/302
43	⊠		US B1	6453100	20020917	85	Display device and method for producing the same	385/120
44			US B1	6410840	20020625	19	Thermoelectric conversion device and method of manufacturing the same	136/201
45	×		US B2	6404792	20020611	20	Semiconductor light-emitting device	372/46
46	×		US B1	6392729	20020521	12	Liquid crystal display with black matrix formed by a black resin optical shielding layer and a blue filter layer	
47	Ø		US B1	6390830	20020521	10	Bus bar-connecting structure	439/76.2

	υ	1	Doc	cument ID	Issue Date	Pages	Title	Current OR
48	X		US B1	6330166	20011211	28	Electronic-component mounting structure	361/760
49	×		US B1	6313023	20011106	28	Method of fabricating deflection aperture array for electron beam exposure apparatus, wet etching method and apparatus for fabricating the aperture array, and electron beam exposure apparatus having the aperture array	438/597
50	×		US B1	6307527	20011023	13	LED display assembly	345/39
51	×		US B1	6281524	20010828	20	Semiconductor light-emitting device	25,7/99
52	×		US B1	6271548	20010807	40	Master slice LSI and layout method for the same	257/202
53			US B1	6241532	20010605	10	High density electrical connector assembly and connector for use therewith	439/67
54	⊠		US B1	6194312	20010227	16	Semiconductor device and method of manufacturing the same	438/669
55	⊠		US A	5920661	19990706	30	Information recording medium and information reproducing apparatus	382/317

	บ	1	Do	cument ID	Issue Date	Pages	Title	Current OR
56			US A	5901050	19990504	12	Wired base plate and package for electronic parts	361/820
57	×		US A	5880494	19990309	53	Active type photoelectric converting device and an active type solid-state imaging device using the same	257/225
58			US A	5843798	19981201	13	Method for manufacturing semiconductor device having step of forming electrode pins on semiconductor chip using electrode-pin forming mask, and method for testing semiconductor chip using electrode-pin forming mask	438/106
59	×		US A	5841300	19981124	33	Semiconductor integrated circuit apparatus	326/98
60	⊠		A	5764319	19980609	13	Transmissive display device with microlenses and microprisms adjacent counter electrode	349/8
61	Ø		US A	5736814	19980407	7	Vacuum flourescent display apparatus	313/495

	ט	1	Do	cument ID	Issue Date	Pages	Title	Current OR
62	⊠		US A	5578132	19961126	22	Apparatus for heat treating semiconductors at normal pressure and low pressure	118/724
63	⊠		US A	5574311	19961112	13	Device having pins formed of hardened mixture of conductive metal particle and resin	257/697
64	Ø	:	US A	5557564	19960917	45	Signal terminal structure for macro cells and an associated connection method	365/63
65	⊠		US A	5553196	19960903	52	Method for processing data using a neural network having a number of layers equal to an abstraction degree of the pattern to be processed	706/31
66	×		US A	5536955	19960716	38	Electronic devices for use in generating integrated circuit structures and method therefor	257/204
67			US A	5496768	19960305	11	Method of manufacturing polycrystalline silicon thin film	438/487
68	×		US A	5490103	19960206	47	Signal terminal structure for macro cells and an associated connection method	365/63
69	×		US A	5386175	19950131	13	Thin-type picture display device	313/422
70	×		US A	5311443	19940510	8	Rule based floorplanner	716/10
71			US A	5274570	19931228	19	Integrated circuit having metal substrate	716/1

	U	1	Do	cument ID	Issue Date	Pages	Title	Current OR
72	×		US A	5134546	19920728	15	Vehicle control unit structure	361/736
73	×		US A	5091762	19920225	12	Semiconductor memory device with a 3-dimensional structure	257/71
74	×		US A	5070258	19911203	18	Integrated circuit having metal substrate used to provide electrical indication of operation mode of circuits	327/565
75	×		US A	5040994	19910820	13	Connector structure for hybrid integrated circuit	439/76.1
76	×		US A	4973833	19901127	49	Image sensor including logarithmic converters	250/208.1
77	×		US A	4924943	19900515	10	Agricultural pulling machine with automatic pitch vibration damping mechanism	172/1
78	×		US A	4412240	19831025	8	Semiconductor integrated circuit and wiring method	257:/211
79	×		US A	4322740	19820330	12	Solid-state color imaging camera	348/264
80	⊠	0	US E	RE30800	19811117	12	Solid-state video camera	348/264
81	×		US A	4219828	19800826	11	Multidrain metal-oxide-semiconduct or field-effect	257/272
82	⊠		US A	4069501	19780117	12	Solid-state video camera	348/264
83	×		US A	4064532	19771220	18	Solid state color camera	348/275
84	Ø		US A	4063589	19771220	12	Heat exchanger assemblies	165/104.16
85	×		US A	4054906	19771018	20	Solid state color camera	348/264

		U	1	Document ID	Issue Date	Pages	Title	Current OR
8	6	Ø		US 3975760 A	19760817	12	Solid state camera	348/262